

Title (en)

SUPRAMOLECULAR STRUCTURES AND PROCESS FOR MAKING THE SAME

Title (de)

SUPRAMOLEKULARE STRUKTUREN UND VERFAHREN ZU DEREN HERSTELLUNG

Title (fr)

STRUCTURES SUPRAMOLECULAIRES ET LEUR PROCEDE DE PRODUCTION

Publication

EP 1090072 A4 20010509 (EN)

Application

EP 99920048 A 19990427

Priority

- US 9909053 W 19990427
- US 8321598 P 19980427

Abstract (en)

[origin: WO9955714A1] The present invention provides a supramolecular structure produced by the process comprising reacting a multi-generation dendrimer with a monomer, where the dendrimer comprises a core molecule, a plurality of interior generations spherically disposed around the core molecule and an outermost generation comprising a plurality of dentritic branches having terminal groups sufficiently reactive to undergo addition or substitution reactions, where the monomer introduces a labile bond and at least one cross-linkable moiety to the terminal groups of each dentritic branch, and where the cross-linkable moiety is bonded to the terminal group via the labile bond; crosslinking the cross-linkable moieties of adjacent dentritic branches; and cleaving the labile bonds, thereby freeing the dendrimer and forming a molecule encapsulated within a cross-linked shell molecule. The present invention further provides a process for the production of the supramolecular structures.

IPC 1-7

C08L 77/00

IPC 8 full level

C08G 73/04 (2006.01); **C08G 83/00** (2006.01); **C08L 77/00** (2006.01); **C08L 79/02** (2006.01)

CPC (source: EP US)

C08G 83/003 (2013.01 - EP US)

Citation (search report)

- [PA] EP 0893482 A1 19990127 - DOW CORNING [US]
- See references of WO 9955714A1

Designated contracting state (EPC)

AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE

DOCDB simple family (publication)

WO 9955714 A1 19991104; AU 3763299 A 19991116; CN 1307605 A 20010808; EP 1090072 A1 20010411; EP 1090072 A4 20010509; JP 2002513047 A 20020508; US 2001039328 A1 20011108; US 6288197 B1 20010911; US 6794327 B2 20040921

DOCDB simple family (application)

US 9909053 W 19990427; AU 3763299 A 19990427; CN 99807944 A 19990427; EP 99920048 A 19990427; JP 2000545872 A 19990427; US 29988799 A 19990427; US 88811801 A 20010622